

(News Release / Translation)

April 7, 2026

Name of company	V-Technology Co., Ltd.
Name of the Representative	Shigeto Sugimoto / President and CEO
Name of company	LE-TECHNOLOGY Co., Ltd.
Name of the Representative	Duk Lee / President, CEO
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V Technology Receives NEDO Order for DI Exposure System “LAMBDI”

~ Secures Order for World’s First 0.5μm-Class System for Advanced Packaging ~

V Technology Co., Ltd. (Head Office: East Tower 9F, Yokohama Business Park, 134 Godo-cho, Hodogaya-ku, Yokohama, Kanagawa; President and CEO: Shigeto Sugimoto; hereinafter “the Company”) and its consolidated subsidiary, LE-TECHNOLOGY Co., Ltd. (Head Office: DS Ichigaya Building 5F, 2-1 Ichigaya-Hachimancho, Shinjuku-ku, Tokyo; President and CEO: Duk Lee ; hereinafter “LET”), have successfully developed the world’s first L/S = 0.5μm-class DI (Direct Imaging) exposure system “LAMBDI” for interposers and package substrates, and have received an order from NEDO (New Energy and Industrial Technology Development Organization) through Osaka Metropolitan University.

The Group began shipment of DI exposure systems capable of supporting 1μm-level wiring in August 2025, and has since achieved further improvements in resolution, leading to this order. Going forward, the Group will continue to develop innovative technologies that support the advancement of semiconductors and electronic devices, thereby contributing to the development of society.

The impact of this order on the Company’s financial results for the current fiscal year is expected to be minimal.